

Global Ultra-Thin Copper Foil for IC Board Supply, Demand and Key Producers, 2026-2032

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Abstracts

The global Ultra-Thin Copper Foil for IC Board market size is expected to reach \$ 5257 million by 2032, rising at a market growth of 12.2% CAGR during the forecast period (2026-2032).

Ultra-Thin Copper Foil for IC Board refers to high-precision electrodeposited copper foil specifically engineered for integrated circuit (IC) substrate and advanced package substrate applications, featuring extremely low thickness, ultra-smooth surface morphology, and highly controlled crystal structure to support ultra-fine line patterning and high-density interconnection in semiconductor packaging. It provides excellent electrical conductivity, minimal surface roughness, and superior dimensional stability, ensuring signal integrity and reliability in high-frequency and high-speed IC substrates. Production in 2025 totaled 108,571 tons with an average price of \$21,000/ton. The upstream primarily includes high-purity cathode copper and copper sulfate solution, with representative suppliers such as Jiangxi Copper, Tongling Nonferrous Metals, and Freeport-McMoRan. The midstream focuses on precision electrolytic fabrication and advanced surface treatment technologies, emphasizing thickness control, crystal structure optimization, and ultra-low roughness to meet stringent IC substrate manufacturing requirements. The downstream mainly serves computer and server systems, consumer electronics, and automotive electronics sectors, with major customers including Apple, Dell, HP, Huawei, Tesla, and BYD. In 2025, the industry's capacity utilization rate reached 93%, while the average gross margin was approximately 30%, reflecting strong demand from advanced packaging and solid profitability across the sector.

This report studies the global Ultra-Thin Copper Foil for IC Board production, demand, key manufacturers, and key regions.

This report is a detailed and comprehensive analysis of the world market for Ultra-Thin Copper Foil for IC Board and provides market size (US\$ million) and Year-over-Year (YoY) Growth, considering 2025 as the base year. This report explores demand trends and competition, as well as details the characteristics of Ultra-Thin Copper Foil for IC Board that contribute to its increasing demand across many markets.

Highlights and key features of the study

Global Ultra-Thin Copper Foil for IC Board total production and demand, 2021-2032, (Tons)

Global Ultra-Thin Copper Foil for IC Board total production value, 2021-2032, (USD Million)

Global Ultra-Thin Copper Foil for IC Board production by region & country, production, value, CAGR, 2021-2032, (USD Million) & (Tons), (based on production site)

Global Ultra-Thin Copper Foil for IC Board consumption by region & country, CAGR, 2021-2032 & (Tons)

U.S. VS China: Ultra-Thin Copper Foil for IC Board domestic production, consumption, key domestic manufacturers and share

Global Ultra-Thin Copper Foil for IC Board production by manufacturer, production, price, value and market share 2021-2026, (USD Million) & (Tons)

Global Ultra-Thin Copper Foil for IC Board production by Type, production, value, CAGR, 2021-2032, (USD Million) & (Tons)

Global Ultra-Thin Copper Foil for IC Board production by Application, production, value, CAGR, 2021-2032, (USD Million) & (Tons)

This report profiles key players in the global Ultra-Thin Copper Foil for IC Board market based on the following parameters - company overview, production, value, price, gross margin, product portfolio, geographical presence, and key developments. Key companies covered as a part of this study include Mitsui Kinzoku, Furukawa Electric, JX Nippon Mining & Metal, Fukuda Metal Foil & Powder, Solus Advanced Materials, Jiangxi JCC Copper Foil, Jiujiang Defu, Hubei Zhongyi Technology, Nan Ya Plastics Corporation, Kingboard, etc.

This report also provides key insights about market drivers, restraints, opportunities, new product launches or approvals.

Stakeholders would have ease in decision-making through various strategy matrices used in analyzing the World Ultra-Thin Copper Foil for IC Board market

Detailed Segmentation:

Each section contains quantitative market data including market by value (US\$ Millions), volume (production, consumption) & (Tons) and average price (US\$/Ton) by manufacturer, by Type, and by Application. Data is given for the years 2021-2032 by year with 2025 as the base year, 2026 as the estimate year, and 2027-2032 as the forecast year.

Global Ultra-Thin Copper Foil for IC Board Market, By Region:

United States

China

Europe

Japan

South Korea

ASEAN

India

Rest of World

Global Ultra-Thin Copper Foil for IC Board Market, Segmentation by Type:

Standard Copper Foil

RTF Copper Foil

VLP Copper Foil

Others

Global Ultra-Thin Copper Foil for IC Board Market, Segmentation by Thickness:

9-12%
12-16%
16-20%
Others

Global Ultra-Thin Copper Foil for IC Board Market, Segmentation by Elongation:

Global Ultra-Thin Copper Foil for IC Board Market, Segmentation by Application:

Computers and Servers

Consumer Electronics

Automotive Electronics

Others

Companies Profiled:

Mitsui Kinzoku

Furukawa Electric

JX Nippon Mining & Metal

Fukuda Metal Foil & Powder

Solus Advanced Materials

Jiangxi JCC Copper Foil

Jiujiang Defu

Hubei Zhongyi Technology

Nan Ya Plastics Corporation

Kingboard

Jiayuan Technology

Key Questions Answered:

1. How big is the global Ultra-Thin Copper Foil for IC Board market?
2. What is the demand of the global Ultra-Thin Copper Foil for IC Board market?
3. What is the year over year growth of the global Ultra-Thin Copper Foil for IC Board market?
4. What is the production and production value of the global Ultra-Thin Copper Foil for IC Board market?
5. Who are the key producers in the global Ultra-Thin Copper Foil for IC Board market?
6. What are the growth factors driving the market demand?

Contents

1 SUPPLY SUMMARY

- 1.1 Ultra-Thin Copper Foil for IC Board Introduction
- 1.2 World Ultra-Thin Copper Foil for IC Board Supply & Forecast
 - 1.2.1 World Ultra-Thin Copper Foil for IC Board Production Value (2021 & 2025 & 2032)
 - 1.2.2 World Ultra-Thin Copper Foil for IC Board Production (2021-2032)
 - 1.2.3 World Ultra-Thin Copper Foil for IC Board Pricing Trends (2021-2032)
- 1.3 World Ultra-Thin Copper Foil for IC Board Production by Region (Based on Production Site)
 - 1.3.1 World Ultra-Thin Copper Foil for IC Board Production Value by Region (2021-2032)
 - 1.3.2 World Ultra-Thin Copper Foil for IC Board Production by Region (2021-2032)
 - 1.3.3 World Ultra-Thin Copper Foil for IC Board Average Price by Region (2021-2032)
 - 1.3.4 North America Ultra-Thin Copper Foil for IC Board Production (2021-2032)
 - 1.3.5 Europe Ultra-Thin Copper Foil for IC Board Production (2021-2032)
 - 1.3.6 China Ultra-Thin Copper Foil for IC Board Production (2021-2032)
 - 1.3.7 Japan Ultra-Thin Copper Foil for IC Board Production (2021-2032)
 - 1.3.8 India Ultra-Thin Copper Foil for IC Board Production (2021-2032)
 - 1.3.9 Southeast Asia Ultra-Thin Copper Foil for IC Board Production (2021-2032)
- 1.4 Market Drivers, Restraints and Trends
 - 1.4.1 Ultra-Thin Copper Foil for IC Board Market Drivers
 - 1.4.2 Factors Affecting Demand
 - 1.4.3 Ultra-Thin Copper Foil for IC Board Major Market Trends

2 DEMAND SUMMARY

- 2.1 World Ultra-Thin Copper Foil for IC Board Demand (2021-2032)
- 2.2 World Ultra-Thin Copper Foil for IC Board Consumption by Region
 - 2.2.1 World Ultra-Thin Copper Foil for IC Board Consumption by Region (2021-2026)
 - 2.2.2 World Ultra-Thin Copper Foil for IC Board Consumption Forecast by Region (2027-2032)
- 2.3 United States Ultra-Thin Copper Foil for IC Board Consumption (2021-2032)
- 2.4 China Ultra-Thin Copper Foil for IC Board Consumption (2021-2032)
- 2.5 Europe Ultra-Thin Copper Foil for IC Board Consumption (2021-2032)
- 2.6 Japan Ultra-Thin Copper Foil for IC Board Consumption (2021-2032)
- 2.7 South Korea Ultra-Thin Copper Foil for IC Board Consumption (2021-2032)
- 2.8 ASEAN Ultra-Thin Copper Foil for IC Board Consumption (2021-2032)

2.9 India Ultra-Thin Copper Foil for IC Board Consumption (2021-2032)

3 WORLD MANUFACTURERS COMPETITIVE ANALYSIS

3.1 World Ultra-Thin Copper Foil for IC Board Production Value by Manufacturer (2021-2026)

3.2 World Ultra-Thin Copper Foil for IC Board Production by Manufacturer (2021-2026)

3.3 World Ultra-Thin Copper Foil for IC Board Average Price by Manufacturer (2021-2026)

3.4 Ultra-Thin Copper Foil for IC Board Company Evaluation Quadrant

3.5 Industry Rank and Concentration Rate (CR)

3.5.1 Global Ultra-Thin Copper Foil for IC Board Industry Rank of Major Manufacturers

3.5.2 Global Concentration Ratios (CR4) for Ultra-Thin Copper Foil for IC Board in 2025

3.5.3 Global Concentration Ratios (CR8) for Ultra-Thin Copper Foil for IC Board in 2025

3.6 Ultra-Thin Copper Foil for IC Board Market: Overall Company Footprint Analysis

3.6.1 Ultra-Thin Copper Foil for IC Board Market: Region Footprint

3.6.2 Ultra-Thin Copper Foil for IC Board Market: Company Product Type Footprint

3.6.3 Ultra-Thin Copper Foil for IC Board Market: Company Product Application Footprint

3.7 Competitive Environment

3.7.1 Historical Structure of the Industry

3.7.2 Barriers of Market Entry

3.7.3 Factors of Competition

3.8 New Entrant and Capacity Expansion Plans

3.9 Mergers, Acquisition, Agreements, and Collaborations

4 UNITED STATES VS CHINA VS REST OF THE WORLD

4.1 United States VS China: Ultra-Thin Copper Foil for IC Board Production Value Comparison

4.1.1 United States VS China: Ultra-Thin Copper Foil for IC Board Production Value Comparison (2021 & 2025 & 2032)

4.1.2 United States VS China: Ultra-Thin Copper Foil for IC Board Production Value Market Share Comparison (2021 & 2025 & 2032)

4.2 United States VS China: Ultra-Thin Copper Foil for IC Board Production Comparison

4.2.1 United States VS China: Ultra-Thin Copper Foil for IC Board Production Comparison (2021 & 2025 & 2032)

4.2.2 United States VS China: Ultra-Thin Copper Foil for IC Board Production Market Share Comparison (2021 & 2025 & 2032)

4.3 United States VS China: Ultra-Thin Copper Foil for IC Board Consumption Comparison

4.3.1 United States VS China: Ultra-Thin Copper Foil for IC Board Consumption Comparison (2021 & 2025 & 2032)

4.3.2 United States VS China: Ultra-Thin Copper Foil for IC Board Consumption Market Share Comparison (2021 & 2025 & 2032)

4.4 United States Based Ultra-Thin Copper Foil for IC Board Manufacturers and Market Share, 2021-2026

4.4.1 United States Based Ultra-Thin Copper Foil for IC Board Manufacturers, Headquarters and Production Site (States, Country)

4.4.2 United States Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Value (2021-2026)

4.4.3 United States Based Manufacturers Ultra-Thin Copper Foil for IC Board Production (2021-2026)

4.5 China Based Ultra-Thin Copper Foil for IC Board Manufacturers and Market Share

4.5.1 China Based Ultra-Thin Copper Foil for IC Board Manufacturers, Headquarters and Production Site (Province, Country)

4.5.2 China Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Value (2021-2026)

4.5.3 China Based Manufacturers Ultra-Thin Copper Foil for IC Board Production (2021-2026)

4.6 Rest of World Based Ultra-Thin Copper Foil for IC Board Manufacturers and Market Share, 2021-2026

4.6.1 Rest of World Based Ultra-Thin Copper Foil for IC Board Manufacturers, Headquarters and Production Site (State, Country)

4.6.2 Rest of World Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Value (2021-2026)

4.6.3 Rest of World Based Manufacturers Ultra-Thin Copper Foil for IC Board Production (2021-2026)

5 MARKET ANALYSIS BY TYPE

5.1 World Ultra-Thin Copper Foil for IC Board Market Size Overview by Type: 2021 VS 2025 VS 2032

5.2 Segment Introduction by Type

5.2.1 Standard Copper Foil

5.2.2 RTF Copper Foil

5.2.3 VLP Copper Foil

5.2.4 Others

5.3 Market Segment by Type

5.3.1 World Ultra-Thin Copper Foil for IC Board Production by Type (2021-2032)

5.3.2 World Ultra-Thin Copper Foil for IC Board Production Value by Type (2021-2032)

5.3.3 World Ultra-Thin Copper Foil for IC Board Average Price by Type (2021-2032)

6 MARKET ANALYSIS BY THICKNESS

6.1 World Ultra-Thin Copper Foil for IC Board Market Size Overview by Thickness: 2021 VS 2025 VS 2032

6.2 Segment Introduction by Thickness

6.2.1 9µm

6.2.2 9-12µm

6.3 Market Segment by Thickness

6.3.1 World Ultra-Thin Copper Foil for IC Board Production by Thickness (2021-2032)

6.3.2 World Ultra-Thin Copper Foil for IC Board Production Value by Thickness (2021-2032)

6.3.3 World Ultra-Thin Copper Foil for IC Board Average Price by Thickness (2021-2032)

7 MARKET ANALYSIS BY ELONGATION

7.1 World Ultra-Thin Copper Foil for IC Board Market Size Overview by Elongation: 2021 VS 2025 VS 2032

7.2 Segment Introduction by Elongation

7.2.1 12-16%

7.2.2 16-20%

7.2.3 Others

7.3 Market Segment by Elongation

7.3.1 World Ultra-Thin Copper Foil for IC Board Production by Elongation (2021-2032)

7.3.2 World Ultra-Thin Copper Foil for IC Board Production Value by Elongation (2021-2032)

7.3.3 World Ultra-Thin Copper Foil for IC Board Average Price by Elongation (2021-2032)

8 MARKET ANALYSIS BY APPLICATION

8.1 World Ultra-Thin Copper Foil for IC Board Market Size Overview by Application: 2021 VS 2025 VS 2032

8.2 Segment Introduction by Application

8.2.1 Computers and Servers

8.2.2 Consumer Electronics

8.2.3 Automotive Electronics

8.2.4 Others

8.3 Market Segment by Application

8.3.1 World Ultra-Thin Copper Foil for IC Board Production by Application (2021-2032)

8.3.2 World Ultra-Thin Copper Foil for IC Board Production Value by Application (2021-2032)

8.3.3 World Ultra-Thin Copper Foil for IC Board Average Price by Application (2021-2032)

9 COMPANY PROFILES

9.1 Mitsui Kinzoku

9.1.1 Mitsui Kinzoku Details

9.1.2 Mitsui Kinzoku Major Business

9.1.3 Mitsui Kinzoku Ultra-Thin Copper Foil for IC Board Product and Services

9.1.4 Mitsui Kinzoku Ultra-Thin Copper Foil for IC Board Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.1.5 Mitsui Kinzoku Recent Developments/Updates

9.1.6 Mitsui Kinzoku Competitive Strengths & Weaknesses

9.2 Furukawa Electric

9.2.1 Furukawa Electric Details

9.2.2 Furukawa Electric Major Business

9.2.3 Furukawa Electric Ultra-Thin Copper Foil for IC Board Product and Services

9.2.4 Furukawa Electric Ultra-Thin Copper Foil for IC Board Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.2.5 Furukawa Electric Recent Developments/Updates

9.2.6 Furukawa Electric Competitive Strengths & Weaknesses

9.3 JX Nippon Mining & Metal

9.3.1 JX Nippon Mining & Metal Details

9.3.2 JX Nippon Mining & Metal Major Business

9.3.3 JX Nippon Mining & Metal Ultra-Thin Copper Foil for IC Board Product and Services

9.3.4 JX Nippon Mining & Metal Ultra-Thin Copper Foil for IC Board Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.3.5 JX Nippon Mining & Metal Recent Developments/Updates

9.3.6 JX Nippon Mining & Metal Competitive Strengths & Weaknesses

9.4 Fukuda Metal Foil & Powder

- 9.4.1 Fukuda Metal Foil & Powder Details
- 9.4.2 Fukuda Metal Foil & Powder Major Business
- 9.4.3 Fukuda Metal Foil & Powder Ultra-Thin Copper Foil for IC Board Product and Services
- 9.4.4 Fukuda Metal Foil & Powder Ultra-Thin Copper Foil for IC Board Production, Price, Value, Gross Margin and Market Share (2021-2026)
- 9.4.5 Fukuda Metal Foil & Powder Recent Developments/Updates
- 9.4.6 Fukuda Metal Foil & Powder Competitive Strengths & Weaknesses
- 9.5 Solus Advanced Materials
- 9.5.1 Solus Advanced Materials Details
- 9.5.2 Solus Advanced Materials Major Business
- 9.5.3 Solus Advanced Materials Ultra-Thin Copper Foil for IC Board Product and Services
- 9.5.4 Solus Advanced Materials Ultra-Thin Copper Foil for IC Board Production, Price, Value, Gross Margin and Market Share (2021-2026)
- 9.5.5 Solus Advanced Materials Recent Developments/Updates
- 9.5.6 Solus Advanced Materials Competitive Strengths & Weaknesses
- 9.6 Jiangxi JCC Copper Foil
- 9.6.1 Jiangxi JCC Copper Foil Details
- 9.6.2 Jiangxi JCC Copper Foil Major Business
- 9.6.3 Jiangxi JCC Copper Foil Ultra-Thin Copper Foil for IC Board Product and Services
- 9.6.4 Jiangxi JCC Copper Foil Ultra-Thin Copper Foil for IC Board Production, Price, Value, Gross Margin and Market Share (2021-2026)
- 9.6.5 Jiangxi JCC Copper Foil Recent Developments/Updates
- 9.6.6 Jiangxi JCC Copper Foil Competitive Strengths & Weaknesses
- 9.7 Jiujiang Defu
- 9.7.1 Jiujiang Defu Details
- 9.7.2 Jiujiang Defu Major Business
- 9.7.3 Jiujiang Defu Ultra-Thin Copper Foil for IC Board Product and Services
- 9.7.4 Jiujiang Defu Ultra-Thin Copper Foil for IC Board Production, Price, Value, Gross Margin and Market Share (2021-2026)
- 9.7.5 Jiujiang Defu Recent Developments/Updates
- 9.7.6 Jiujiang Defu Competitive Strengths & Weaknesses
- 9.8 Hubei Zhongyi Technology
- 9.8.1 Hubei Zhongyi Technology Details
- 9.8.2 Hubei Zhongyi Technology Major Business
- 9.8.3 Hubei Zhongyi Technology Ultra-Thin Copper Foil for IC Board Product and Services
- 9.8.4 Hubei Zhongyi Technology Ultra-Thin Copper Foil for IC Board Production, Price,

Value, Gross Margin and Market Share (2021-2026)

9.8.5 Hubei Zhongyi Technology Recent Developments/Updates

9.8.6 Hubei Zhongyi Technology Competitive Strengths & Weaknesses

9.9 Nan Ya Plastics Corporation

9.9.1 Nan Ya Plastics Corporation Details

9.9.2 Nan Ya Plastics Corporation Major Business

9.9.3 Nan Ya Plastics Corporation Ultra-Thin Copper Foil for IC Board Product and Services

9.9.4 Nan Ya Plastics Corporation Ultra-Thin Copper Foil for IC Board Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.9.5 Nan Ya Plastics Corporation Recent Developments/Updates

9.9.6 Nan Ya Plastics Corporation Competitive Strengths & Weaknesses

9.10 Kingboard

9.10.1 Kingboard Details

9.10.2 Kingboard Major Business

9.10.3 Kingboard Ultra-Thin Copper Foil for IC Board Product and Services

9.10.4 Kingboard Ultra-Thin Copper Foil for IC Board Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.10.5 Kingboard Recent Developments/Updates

9.10.6 Kingboard Competitive Strengths & Weaknesses

9.11 Jiayuan Technology

9.11.1 Jiayuan Technology Details

9.11.2 Jiayuan Technology Major Business

9.11.3 Jiayuan Technology Ultra-Thin Copper Foil for IC Board Product and Services

9.11.4 Jiayuan Technology Ultra-Thin Copper Foil for IC Board Production, Price, Value, Gross Margin and Market Share (2021-2026)

9.11.5 Jiayuan Technology Recent Developments/Updates

9.11.6 Jiayuan Technology Competitive Strengths & Weaknesses

10 INDUSTRY CHAIN ANALYSIS

10.1 Ultra-Thin Copper Foil for IC Board Industry Chain

10.2 Ultra-Thin Copper Foil for IC Board Upstream Analysis

10.2.1 Ultra-Thin Copper Foil for IC Board Core Raw Materials

10.2.2 Main Manufacturers of Ultra-Thin Copper Foil for IC Board Core Raw Materials

10.3 Midstream Analysis

10.4 Downstream Analysis

10.5 Ultra-Thin Copper Foil for IC Board Production Mode

10.6 Ultra-Thin Copper Foil for IC Board Procurement Model

10.7 Ultra-Thin Copper Foil for IC Board Industry Sales Model and Sales Channels

10.7.1 Ultra-Thin Copper Foil for IC Board Sales Model

10.7.2 Ultra-Thin Copper Foil for IC Board Typical Distributors

11 RESEARCH FINDINGS AND CONCLUSION

12 APPENDIX

12.1 Methodology

12.2 Research Process and Data Source

12.3 Disclaimer

List Of Tables

LIST OF TABLES

Table 1. World Ultra-Thin Copper Foil for IC Board Production Value by Region (2021, 2025 and 2032) & (USD Million)

Table 2. World Ultra-Thin Copper Foil for IC Board Production Value by Region (2021-2026) & (USD Million)

Table 3. World Ultra-Thin Copper Foil for IC Board Production Value by Region (2027-2032) & (USD Million)

Table 4. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by Region (2021-2026)

Table 5. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by Region (2027-2032)

Table 6. World Ultra-Thin Copper Foil for IC Board Production by Region (2021-2026) & (Tons)

Table 7. World Ultra-Thin Copper Foil for IC Board Production by Region (2027-2032) & (Tons)

Table 8. World Ultra-Thin Copper Foil for IC Board Production Market Share by Region (2021-2026)

Table 9. World Ultra-Thin Copper Foil for IC Board Production Market Share by Region (2027-2032)

Table 10. World Ultra-Thin Copper Foil for IC Board Average Price by Region (2021-2026) & (US\$/Ton)

Table 11. World Ultra-Thin Copper Foil for IC Board Average Price by Region (2027-2032) & (US\$/Ton)

Table 12. Ultra-Thin Copper Foil for IC Board Major Market Trends

Table 13. World Ultra-Thin Copper Foil for IC Board Consumption Growth Rate Forecast by Region (2021 & 2025 & 2032) & (Tons)

Table 14. World Ultra-Thin Copper Foil for IC Board Consumption by Region (2021-2026) & (Tons)

Table 15. World Ultra-Thin Copper Foil for IC Board Consumption Forecast by Region (2027-2032) & (Tons)

Table 16. World Ultra-Thin Copper Foil for IC Board Production Value by Manufacturer (2021-2026) & (USD Million)

Table 17. Production Value Market Share of Key Ultra-Thin Copper Foil for IC Board Producers in 2025

Table 18. World Ultra-Thin Copper Foil for IC Board Production by Manufacturer (2021-2026) & (Tons)

Table 19. Production Market Share of Key Ultra-Thin Copper Foil for IC Board Producers in 2025

Table 20. World Ultra-Thin Copper Foil for IC Board Average Price by Manufacturer (2021-2026) & (US\$/Ton)

Table 21. Global Ultra-Thin Copper Foil for IC Board Company Evaluation Quadrant

Table 22. World Ultra-Thin Copper Foil for IC Board Industry Rank of Major Manufacturers, Based on Production Value in 2025

Table 23. Head Office and Ultra-Thin Copper Foil for IC Board Production Site of Key Manufacturer

Table 24. Ultra-Thin Copper Foil for IC Board Market: Company Product Type Footprint

Table 25. Ultra-Thin Copper Foil for IC Board Market: Company Product Application Footprint

Table 26. Ultra-Thin Copper Foil for IC Board Competitive Factors

Table 27. Ultra-Thin Copper Foil for IC Board New Entrant and Capacity Expansion Plans

Table 28. Ultra-Thin Copper Foil for IC Board Mergers & Acquisitions Activity

Table 29. United States VS China Ultra-Thin Copper Foil for IC Board Production Value Comparison, (2021 & 2025 & 2032) & (USD Million)

Table 30. United States VS China Ultra-Thin Copper Foil for IC Board Production Comparison, (2021 & 2025 & 2032) & (Tons)

Table 31. United States VS China Ultra-Thin Copper Foil for IC Board Consumption Comparison, (2021 & 2025 & 2032) & (Tons)

Table 32. United States Based Ultra-Thin Copper Foil for IC Board Manufacturers, Headquarters and Production Site (States, Country)

Table 33. United States Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Value, (2021-2026) & (USD Million)

Table 34. United States Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Value Market Share (2021-2026)

Table 35. United States Based Manufacturers Ultra-Thin Copper Foil for IC Board Production (2021-2026) & (Tons)

Table 36. United States Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Market Share (2021-2026)

Table 37. China Based Ultra-Thin Copper Foil for IC Board Manufacturers, Headquarters and Production Site (Province, Country)

Table 38. China Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Value, (2021-2026) & (USD Million)

Table 39. China Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Value Market Share (2021-2026)

Table 40. China Based Manufacturers Ultra-Thin Copper Foil for IC Board Production,

(2021-2026) & (Tons)

Table 41. China Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Market Share (2021-2026)

Table 42. Rest of World Based Ultra-Thin Copper Foil for IC Board Manufacturers, Headquarters and Production Site (State, Country)

Table 43. Rest of World Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Value, (2021-2026) & (USD Million)

Table 44. Rest of World Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Value Market Share (2021-2026)

Table 45. Rest of World Based Manufacturers Ultra-Thin Copper Foil for IC Board Production, (2021-2026) & (Tons)

Table 46. Rest of World Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Market Share (2021-2026)

Table 47. World Ultra-Thin Copper Foil for IC Board Production Value by Type, (USD Million), 2021 & 2025 & 2032

Table 48. World Ultra-Thin Copper Foil for IC Board Production by Type (2021-2026) & (Tons)

Table 49. World Ultra-Thin Copper Foil for IC Board Production by Type (2027-2032) & (Tons)

Table 50. World Ultra-Thin Copper Foil for IC Board Production Value by Type (2021-2026) & (USD Million)

Table 51. World Ultra-Thin Copper Foil for IC Board Production Value by Type (2027-2032) & (USD Million)

Table 52. World Ultra-Thin Copper Foil for IC Board Average Price by Type (2021-2026) & (US\$/Ton)

Table 53. World Ultra-Thin Copper Foil for IC Board Average Price by Type (2027-2032) & (US\$/Ton)

Table 54. World Ultra-Thin Copper Foil for IC Board Production Value by Thickness, (USD Million), 2021 & 2025 & 2032

Table 55. World Ultra-Thin Copper Foil for IC Board Production by Thickness (2021-2026) & (Tons)

Table 56. World Ultra-Thin Copper Foil for IC Board Production by Thickness (2027-2032) & (Tons)

Table 57. World Ultra-Thin Copper Foil for IC Board Production Value by Thickness (2021-2026) & (USD Million)

Table 58. World Ultra-Thin Copper Foil for IC Board Production Value by Thickness (2027-2032) & (USD Million)

Table 59. World Ultra-Thin Copper Foil for IC Board Average Price by Thickness (2021-2026) & (US\$/Ton)

Table 60. World Ultra-Thin Copper Foil for IC Board Average Price by Thickness (2027-2032) & (US\$/Ton)

Table 61. World Ultra-Thin Copper Foil for IC Board Production Value by Elongation, (USD Million), 2021 & 2025 & 2032

Table 62. World Ultra-Thin Copper Foil for IC Board Production by Elongation (2021-2026) & (Tons)

Table 63. World Ultra-Thin Copper Foil for IC Board Production by Elongation (2027-2032) & (Tons)

Table 64. World Ultra-Thin Copper Foil for IC Board Production Value by Elongation (2021-2026) & (USD Million)

Table 65. World Ultra-Thin Copper Foil for IC Board Production Value by Elongation (2027-2032) & (USD Million)

Table 66. World Ultra-Thin Copper Foil for IC Board Average Price by Elongation (2021-2026) & (US\$/Ton)

Table 67. World Ultra-Thin Copper Foil for IC Board Average Price by Elongation (2027-2032) & (US\$/Ton)

Table 68. World Ultra-Thin Copper Foil for IC Board Production Value by Application, (USD Million), 2021 & 2025 & 2032

Table 69. World Ultra-Thin Copper Foil for IC Board Production by Application (2021-2026) & (Tons)

Table 70. World Ultra-Thin Copper Foil for IC Board Production by Application (2027-2032) & (Tons)

Table 71. World Ultra-Thin Copper Foil for IC Board Production Value by Application (2021-2026) & (USD Million)

Table 72. World Ultra-Thin Copper Foil for IC Board Production Value by Application (2027-2032) & (USD Million)

Table 73. World Ultra-Thin Copper Foil for IC Board Average Price by Application (2021-2026) & (US\$/Ton)

Table 74. World Ultra-Thin Copper Foil for IC Board Average Price by Application (2027-2032) & (US\$/Ton)

Table 75. Mitsui Kinzoku Basic Information, Manufacturing Base and Competitors

Table 76. Mitsui Kinzoku Major Business

Table 77. Mitsui Kinzoku Ultra-Thin Copper Foil for IC Board Product and Services

Table 78. Mitsui Kinzoku Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 79. Mitsui Kinzoku Recent Developments/Updates

Table 80. Mitsui Kinzoku Competitive Strengths & Weaknesses

Table 81. Furukawa Electric Basic Information, Manufacturing Base and Competitors

Table 82. Furukawa Electric Major Business

Table 83. Furukawa Electric Ultra-Thin Copper Foil for IC Board Product and Services

Table 84. Furukawa Electric Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 85. Furukawa Electric Recent Developments/Updates

Table 86. Furukawa Electric Competitive Strengths & Weaknesses

Table 87. JX Nippon Mining & Metal Basic Information, Manufacturing Base and Competitors

Table 88. JX Nippon Mining & Metal Major Business

Table 89. JX Nippon Mining & Metal Ultra-Thin Copper Foil for IC Board Product and Services

Table 90. JX Nippon Mining & Metal Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 91. JX Nippon Mining & Metal Recent Developments/Updates

Table 92. JX Nippon Mining & Metal Competitive Strengths & Weaknesses

Table 93. Fukuda Metal Foil & Powder Basic Information, Manufacturing Base and Competitors

Table 94. Fukuda Metal Foil & Powder Major Business

Table 95. Fukuda Metal Foil & Powder Ultra-Thin Copper Foil for IC Board Product and Services

Table 96. Fukuda Metal Foil & Powder Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 97. Fukuda Metal Foil & Powder Recent Developments/Updates

Table 98. Fukuda Metal Foil & Powder Competitive Strengths & Weaknesses

Table 99. Solus Advanced Materials Basic Information, Manufacturing Base and Competitors

Table 100. Solus Advanced Materials Major Business

Table 101. Solus Advanced Materials Ultra-Thin Copper Foil for IC Board Product and Services

Table 102. Solus Advanced Materials Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 103. Solus Advanced Materials Recent Developments/Updates

Table 104. Solus Advanced Materials Competitive Strengths & Weaknesses

Table 105. Jiangxi JCC Copper Foil Basic Information, Manufacturing Base and Competitors

Table 106. Jiangxi JCC Copper Foil Major Business

Table 107. Jiangxi JCC Copper Foil Ultra-Thin Copper Foil for IC Board Product and Services

Table 108. Jiangxi JCC Copper Foil Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 109. Jiangxi JCC Copper Foil Recent Developments/Updates

Table 110. Jiangxi JCC Copper Foil Competitive Strengths & Weaknesses

Table 111. Jiujiang Defu Basic Information, Manufacturing Base and Competitors

Table 112. Jiujiang Defu Major Business

Table 113. Jiujiang Defu Ultra-Thin Copper Foil for IC Board Product and Services

Table 114. Jiujiang Defu Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 115. Jiujiang Defu Recent Developments/Updates

Table 116. Jiujiang Defu Competitive Strengths & Weaknesses

Table 117. Hubei Zhongyi Technology Basic Information, Manufacturing Base and Competitors

Table 118. Hubei Zhongyi Technology Major Business

Table 119. Hubei Zhongyi Technology Ultra-Thin Copper Foil for IC Board Product and Services

Table 120. Hubei Zhongyi Technology Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 121. Hubei Zhongyi Technology Recent Developments/Updates

Table 122. Hubei Zhongyi Technology Competitive Strengths & Weaknesses

Table 123. Nan Ya Plastics Corporation Basic Information, Manufacturing Base and Competitors

Table 124. Nan Ya Plastics Corporation Major Business

Table 125. Nan Ya Plastics Corporation Ultra-Thin Copper Foil for IC Board Product and Services

Table 126. Nan Ya Plastics Corporation Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 127. Nan Ya Plastics Corporation Recent Developments/Updates

Table 128. Nan Ya Plastics Corporation Competitive Strengths & Weaknesses

Table 129. Kingboard Basic Information, Manufacturing Base and Competitors

Table 130. Kingboard Major Business

Table 131. Kingboard Ultra-Thin Copper Foil for IC Board Product and Services

Table 132. Kingboard Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 133. Kingboard Recent Developments/Updates

Table 134. Kingboard Competitive Strengths & Weaknesses

Table 135. Jiayuan Technology Basic Information, Manufacturing Base and Competitors

Table 136. Jiayuan Technology Major Business

Table 137. Jiayuan Technology Ultra-Thin Copper Foil for IC Board Product and Services

Table 138. Jiayuan Technology Ultra-Thin Copper Foil for IC Board Production (Tons), Price (US\$/Ton), Production Value (USD Million), Gross Margin and Market Share (2021-2026)

Table 139. Jiayuan Technology Recent Developments/Updates

Table 140. Jiayuan Technology Competitive Strengths & Weaknesses

Table 141. Global Key Players of Ultra-Thin Copper Foil for IC Board Upstream (Raw Materials)

Table 142. Global Ultra-Thin Copper Foil for IC Board Typical Customers

Table 143. Ultra-Thin Copper Foil for IC Board Typical Distributors

List Of Figures

LIST OF FIGURES

Figure 1. Ultra-Thin Copper Foil for IC Board Picture

Figure 2. World Ultra-Thin Copper Foil for IC Board Production Value: 2021 & 2025 & 2032, (USD Million)

Figure 3. World Ultra-Thin Copper Foil for IC Board Production Value and Forecast (2021-2032) & (USD Million)

Figure 4. World Ultra-Thin Copper Foil for IC Board Production (2021-2032) & (Tons)

Figure 5. World Ultra-Thin Copper Foil for IC Board Average Price (2021-2032) & (US\$/Ton)

Figure 6. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by Region (2021-2032)

Figure 7. World Ultra-Thin Copper Foil for IC Board Production Market Share by Region (2021-2032)

Figure 8. North America Ultra-Thin Copper Foil for IC Board Production (2021-2032) & (Tons)

Figure 9. Europe Ultra-Thin Copper Foil for IC Board Production (2021-2032) & (Tons)

Figure 10. China Ultra-Thin Copper Foil for IC Board Production (2021-2032) & (Tons)

Figure 11. Japan Ultra-Thin Copper Foil for IC Board Production (2021-2032) & (Tons)

Figure 12. India Ultra-Thin Copper Foil for IC Board Production (2021-2032) & (Tons)

Figure 13. Southeast Asia Ultra-Thin Copper Foil for IC Board Production (2021-2032) & (Tons)

Figure 14. Ultra-Thin Copper Foil for IC Board Market Drivers

Figure 15. Factors Affecting Demand

Figure 16. World Ultra-Thin Copper Foil for IC Board Consumption (2021-2032) & (Tons)

Figure 17. World Ultra-Thin Copper Foil for IC Board Consumption Market Share by Region (2021-2032)

Figure 18. United States Ultra-Thin Copper Foil for IC Board Consumption (2021-2032) & (Tons)

Figure 19. China Ultra-Thin Copper Foil for IC Board Consumption (2021-2032) & (Tons)

Figure 20. Europe Ultra-Thin Copper Foil for IC Board Consumption (2021-2032) & (Tons)

Figure 21. Japan Ultra-Thin Copper Foil for IC Board Consumption (2021-2032) & (Tons)

Figure 22. South Korea Ultra-Thin Copper Foil for IC Board Consumption (2021-2032) &

(Tons)

Figure 23. ASEAN Ultra-Thin Copper Foil for IC Board Consumption (2021-2032) & (Tons)

Figure 24. India Ultra-Thin Copper Foil for IC Board Consumption (2021-2032) & (Tons)

Figure 25. Producer Shipments of Ultra-Thin Copper Foil for IC Board by Manufacturer Revenue (\$MM) and Market Share (%): 2025

Figure 26. Global Four-firm Concentration Ratios (CR4) for Ultra-Thin Copper Foil for IC Board Markets in 2025

Figure 27. Global Four-firm Concentration Ratios (CR8) for Ultra-Thin Copper Foil for IC Board Markets in 2025

Figure 28. United States VS China: Ultra-Thin Copper Foil for IC Board Production Value Market Share Comparison (2021 & 2025 & 2032)

Figure 29. United States VS China: Ultra-Thin Copper Foil for IC Board Production Market Share Comparison (2021 & 2025 & 2032)

Figure 30. United States VS China: Ultra-Thin Copper Foil for IC Board Consumption Market Share Comparison (2021 & 2025 & 2032)

Figure 31. United States Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Market Share 2025

Figure 32. China Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Market Share 2025

Figure 33. Rest of World Based Manufacturers Ultra-Thin Copper Foil for IC Board Production Market Share 2025

Figure 34. World Ultra-Thin Copper Foil for IC Board Production Value by Type, (USD Million), 2021 & 2025 & 2032

Figure 35. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by Type in 2025

Figure 36. Standard Copper Foil

Figure 37. RTF Copper Foil

Figure 38. VLP Copper Foil

Figure 39. Others

Figure 40. World Ultra-Thin Copper Foil for IC Board Production Market Share by Type (2021-2032)

Figure 41. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by Type (2021-2032)

Figure 42. World Ultra-Thin Copper Foil for IC Board Average Price by Type (2021-2032) & (US\$/Ton)

Figure 43. World Ultra-Thin Copper Foil for IC Board Production Value by Thickness, (USD Million), 2021 & 2025 & 2032

Figure 44. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by

Thickness in 2025

Figure 45. 9-12µm

Figure 46. 9-12µm

Figure 47. World Ultra-Thin Copper Foil for IC Board Production Market Share by Thickness (2021-2032)

Figure 48. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by Thickness (2021-2032)

Figure 49. World Ultra-Thin Copper Foil for IC Board Average Price by Thickness (2021-2032) & (US\$/Ton)

Figure 50. World Ultra-Thin Copper Foil for IC Board Production Value by Elongation, (USD Million), 2021 & 2025 & 2032

Figure 51. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by Elongation in 2025

Figure 52. 12-16%

Figure 53. 16-20%

Figure 54. Others

Figure 55. World Ultra-Thin Copper Foil for IC Board Production Market Share by Elongation (2021-2032)

Figure 56. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by Elongation (2021-2032)

Figure 57. World Ultra-Thin Copper Foil for IC Board Average Price by Elongation (2021-2032) & (US\$/Ton)

Figure 58. World Ultra-Thin Copper Foil for IC Board Production Value by Application, (USD Million), 2021 & 2025 & 2032

Figure 59. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by Application in 2025

Figure 60. Computers and Servers

Figure 61. Consumer Electronics

Figure 62. Automotive Electronics

Figure 63. Others

Figure 64. World Ultra-Thin Copper Foil for IC Board Production Market Share by Application (2021-2032)

Figure 65. World Ultra-Thin Copper Foil for IC Board Production Value Market Share by Application (2021-2032)

Figure 66. World Ultra-Thin Copper Foil for IC Board Average Price by Application (2021-2032) & (US\$/Ton)

Figure 67. Ultra-Thin Copper Foil for IC Board Industry Chain

Figure 68. Ultra-Thin Copper Foil for IC Board Procurement Model

Figure 69. Ultra-Thin Copper Foil for IC Board Sales Model

Figure 70. Ultra-Thin Copper Foil for IC Board Sales Channels, Direct Sales, and Distribution

Figure 71. Methodology

Figure 72. Research Process and Data Source

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